

# GTR200HF65A5H

## IGBT Module

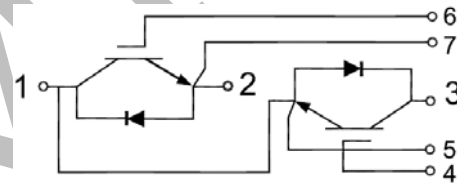
### Features:

- Short Circuit Rated >10 $\mu$ s
- Low Saturation Voltage:  $V_{CE(sat)} = 1.60V @ I_C = 200A, T_C = 25^\circ C$
- Low Switching Loss
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



### Applications:

- UPS and SMPS
- Industrial Inverters
- Servo Applications



### IGBT, Inverter

#### Maximum Rated Values ( $T_C = 25^\circ C$ unless otherwise specified)

$V_{CES}$	Collector-Emitter Blocking Voltage		650	V
$V_{GES}$	Gate-Emitter Voltage		$\pm 20$	V
$I_C$	Continuous Collector Current	$T_C = 80^\circ C,$	200	A
		$T_C = 25^\circ C$	310	A
$I_{CM}$	Repetitive Peak Collector Current	$T_J = 175^\circ C$	400	A
$t_{SC}$	Short Circuit Withstand Time		>10	$\mu$ s
$P_D$	Maximum Power Dissipation per IGBT	$T_C = 25^\circ C$ $T_{Jmax} = 175^\circ C$	994	W

## Electrical Characteristics of IGBT ( $T_C=25^\circ\text{C}$ unless otherwise specified)

### Static characteristics

Symbol	Description	Conditions	Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C = 1 \text{ mA}, V_{CE} = V_{GE}$	5.5	6.0	6.5	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 200\text{A}, V_{GE} = 15\text{V}$	$T_J = 25^\circ\text{C}$	1.60	1.80	V
			$T_J = 125^\circ\text{C}$	1.80	2.00	V
$I_{CES}$	Collector-Emitter Leakage Current	$V_{GE} = 0\text{V}, V_{CE} = V_{CES}, T_J = 25^\circ\text{C}$			1	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE} = \pm 20\text{V}, V_{CE} = 0\text{V}, T_J = 25^\circ\text{C}$			400	nA
$C_{ies}$	Input Capacitance	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$		17.0		nF
$C_{oes}$	Output Capacitance			0.70		nF
$C_{res}$	Reveres Transfer Capacitance			0.56		nF

### Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC} = 300\text{V}, I_C = 200\text{A}, R_G = 15\Omega, V_{GE} = \pm 15\text{V},$ Inductive Load	$T_J = 25^\circ\text{C}$		725		ns
			$T_J = 125^\circ\text{C}$		730		
$t_r$	Rise Time		$T_J = 25^\circ\text{C}$		280		ns
			$T_J = 125^\circ\text{C}$		285		
$t_{d(off)}$	Turn-off Delay Time		$T_J = 25^\circ\text{C}$		720		ns
			$T_J = 125^\circ\text{C}$		735		
$t_f$	Fall Time		$T_J = 25^\circ\text{C}$		115		ns
			$T_J = 125^\circ\text{C}$		120		
$E_{on}$	Turn-on Switching Loss		$T_J = 25^\circ\text{C}$		17.2		mJ
			$T_J = 125^\circ\text{C}$		19.8		
$E_{off}$	Turn-off Switching Loss	$T_J = 25^\circ\text{C}$		11.6		mJ	
		$T_J = 125^\circ\text{C}$		12.5			
$Q_g$	Total Gate Charge	$T_J = 25^\circ\text{C}$		8.2		nC	
SCSOA	Short Circuit Safe Operation Area	$V_{CC} = 300\text{V}, V_{GE} = 15\text{V}, T_J = 150^\circ\text{C}$		10		$\mu\text{s}$	
$R_{\theta JC}$	IGBT Thermal Resistance: Junction-To-Case			0.151		$^\circ\text{C/W}$	

## Diode, Inverter

### Maximum Rated Values ( $T_C=25^\circ\text{C}$ unless otherwise specified)

$V_{RRM}$	Repetitive Peak Reverse Voltage	650	V
$I_F$	Diode Continuous Forward Current	200	A
$I_{FM}$	Diode Maximum Forward Current	400	A

### Electrical Characteristics of FWD ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Description	Conditions	Min	Typ	Max	Unit
$V_{FM}$	Forward Voltage	$I_F = 200\text{A}$	$T_J = 25^\circ\text{C}$	1.45		V
			$T_J = 125^\circ\text{C}$		1.55	
$I_{rr}$	Peak Reverse Recovery Current	$I_F = 200\text{A}$ , $di/dt = 580\text{A}/\mu\text{s}$ , $V_{rr} = 300\text{V}$ , $V_{GE} = -15\text{V}$	$T_J = 25^\circ\text{C}$	40		A
			$T_J = 125^\circ\text{C}$		55	
$Q_{rr}$	Reverse Recovery Charge	$I_F = 200\text{A}$ , $di/dt = 580\text{A}/\mu\text{s}$ , $V_{rr} = 300\text{V}$ , $V_{GE} = -15\text{V}$	$T_J = 25^\circ\text{C}$	4.9		$\mu\text{C}$
			$T_J = 125^\circ\text{C}$		9.1	
$E_{rec}$	Reverse Recovery Energy	$I_F = 200\text{A}$ , $di/dt = 580\text{A}/\mu\text{s}$ , $V_{rr} = 300\text{V}$ , $V_{GE} = -15\text{V}$	$T_J = 25^\circ\text{C}$	1.66		mJ
			$T_J = 125^\circ\text{C}$		2.51	
$R_{\theta JC}$	Diode Thermal Resistance: Junction-To-Case			0.307		$^\circ\text{C}/\text{W}$

## Module

Symbol	Description	Conditions	Min	Typ	Max	Unit
$V_{iso}$	Isolation Voltage (All Terminals Shorted)	$f = 50\text{Hz}$ , 1minute	2500			V
$T_J$	Maximum Junction Temperature				175	$^\circ\text{C}$
$T_{JOP}$	Maximum Operating Junction Temperature Range		-40		+150	$^\circ\text{C}$
$T_{stg}$	Storage Temperature		-40		+125	$^\circ\text{C}$
$R_{\theta CS}$	Case-To-Sink Thermally (Conductive Grease Applied)			0.04		$^\circ\text{C}/\text{W}$
M	Power Terminals Screw:M5		3.0		5.0	N·m
M	Mounting Screw:M6		4.0		6.0	N·m
G	Weight			210		g

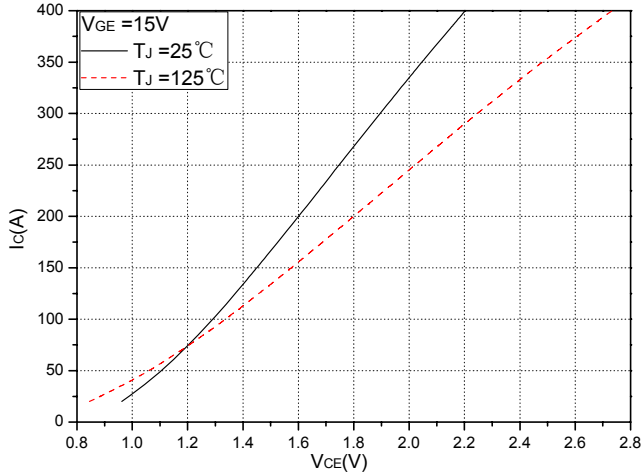


Fig.1 Typical Saturation Voltage Characteristics

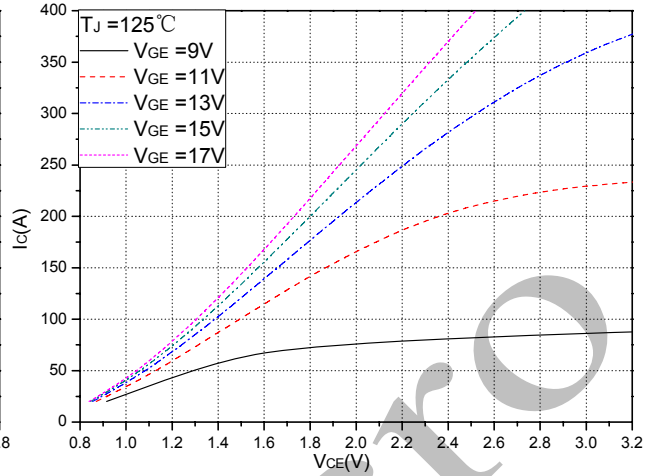


Fig.2 Typical Output Characteristic

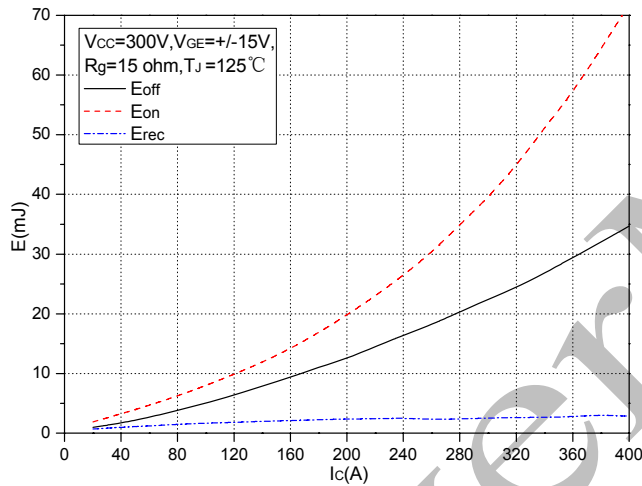


Fig.3 Typical Switching Loss vs. Collector Current

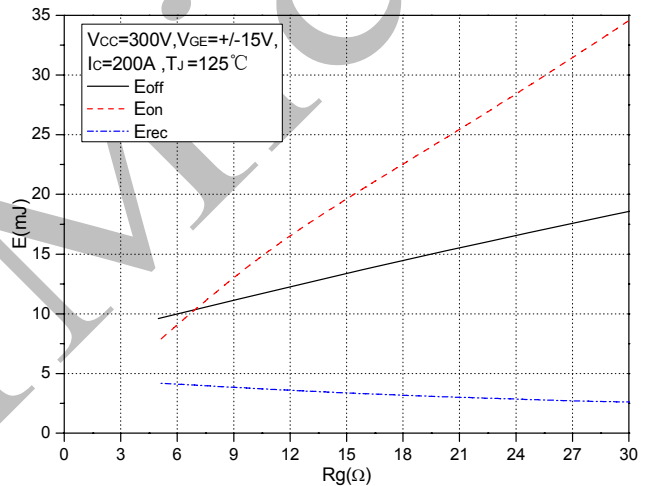


Fig.4 Typical Switching Losses vs. Gate Resistance

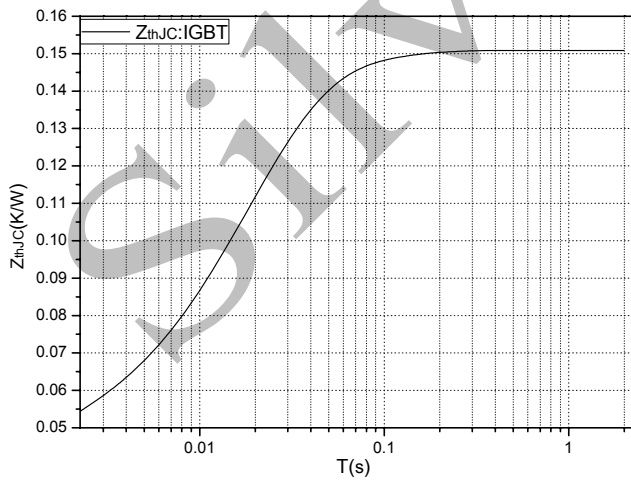


Fig.5 Transient Thermal Impedance (IGBT)

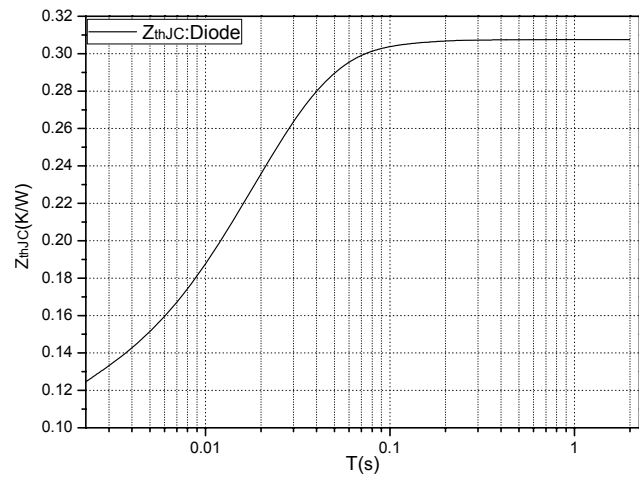


Fig.6 Transient Thermal Impedance (Diode)

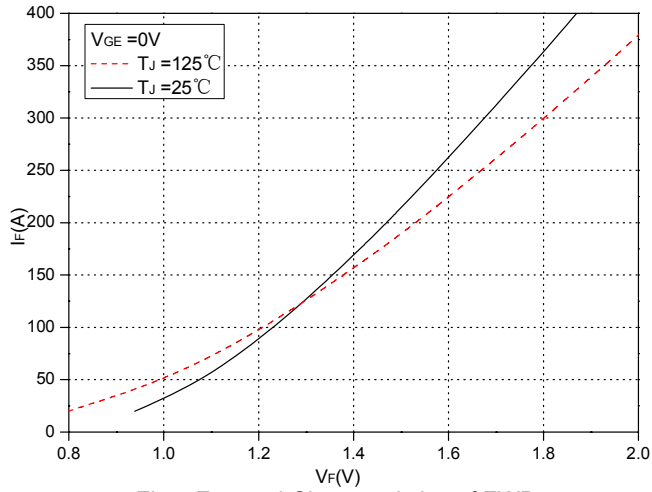
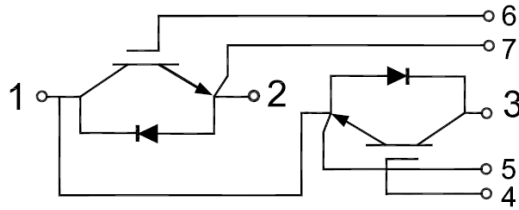


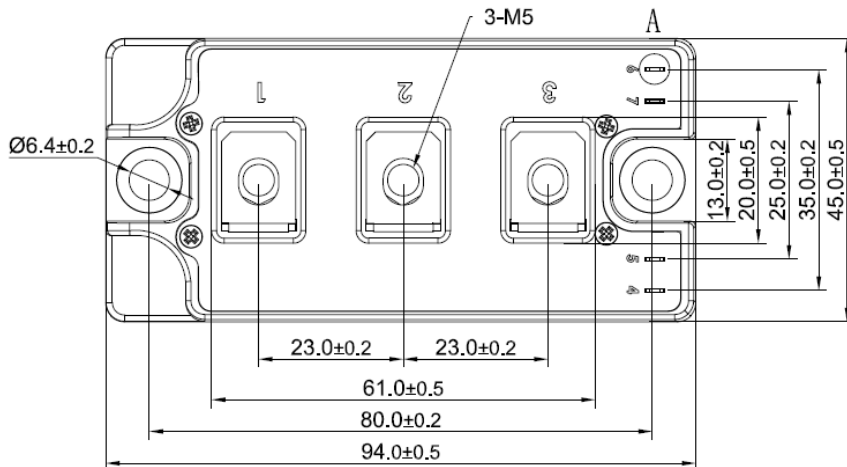
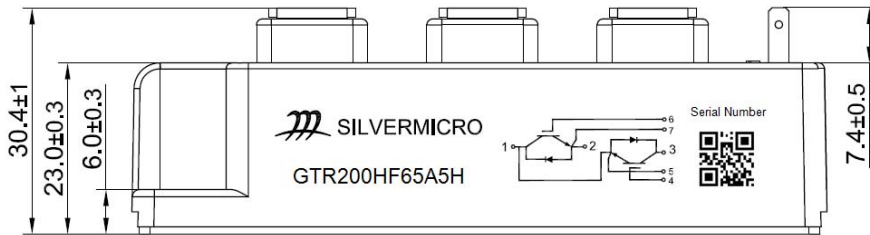
Fig.7 Forward Characteristics of FWD

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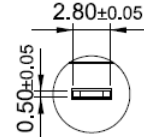
**Internal Circuit:**



**Package Outline (Unit: mm):**



View A  
scale 3:1



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